# Techniques and tools for measuring energy efficiency of scientific software applications



# 1. Why is energy efficiency important on High Throughput Computing (HTC) ?

### 2. Measuring power consumption

Where is energy used?

External measurements

Chip monitors

Software based measurements

#### 3. Study case

External measurements

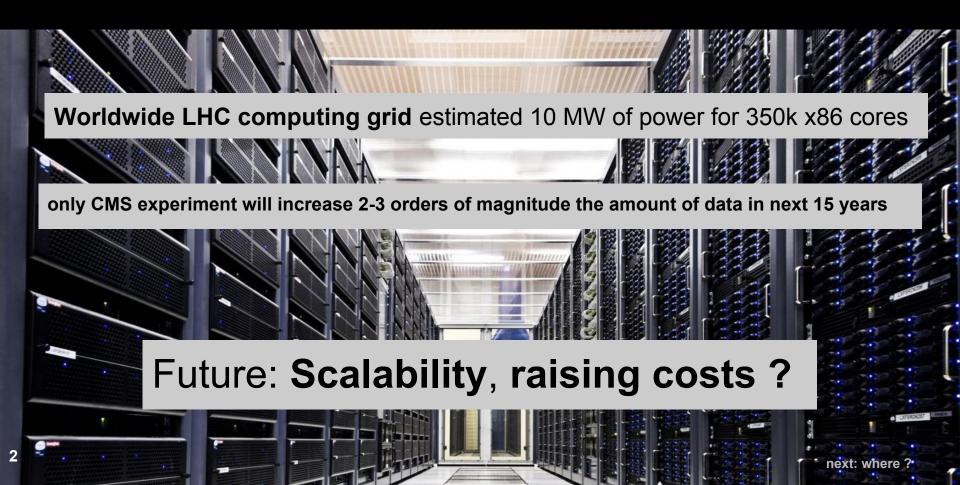
Chip monitors

IgProf for energy measurements

Results: ARM vs Intel comparison

#### 4. Conclusions

1. Why is energy efficiency important on HTC?



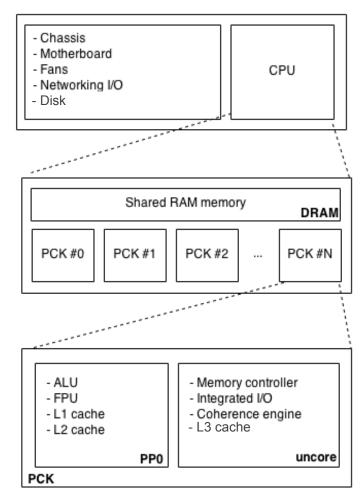
#### 2.1. Where is the energy used?

HTC systems are **complex** 

Several components

Different granularities

**CPU** can be optimised more control than other components



next: external

#### 2.2. Where is energy used ? > External measurements

### Account for the **whole system**

Power consumed without breaking down the system in components

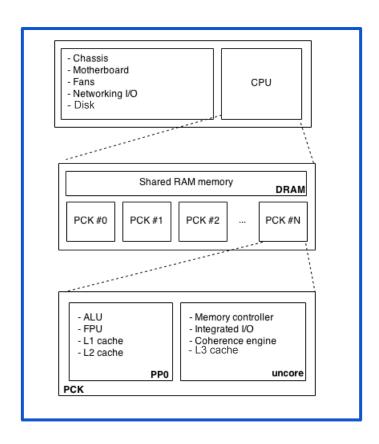
**Accuracy:** around ± 3% for clamps **Resolution** order of seconds (*Hz*)







http://www.racksandpower.com



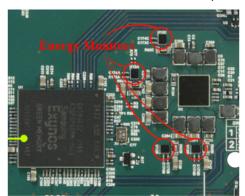
4 next: internal

#### 2.2. Where is energy used ? > Chip monitors

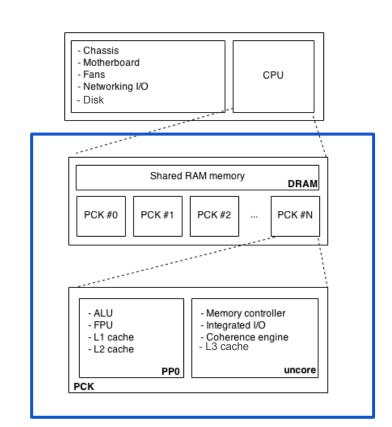
Monitor chips on the motherboard that measure energy consumed by different components of CPU

There is no standard solution.

**Accuracy:** *high* (*ex:* 0.5% gain error) **Resolution** order of microseconds (*MHz*)



Texas Instrument (TI) INA 231 monitoring chip on ODROID XU+E



http://hardkernel.com

next: RAPL ex

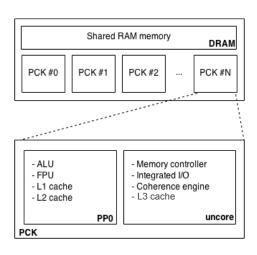
#### 2.2. Where is energy used ? > Chip monitors > RAPL

# Running Average Power Limiting (RAPL) by Intel

Provides a platform for power monitoring and power limiting of SoC.

Different sampling domains

package (PKG), DRAM, core



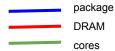
Low level measurements package, cores, dram

**Resolution** according to Intel, sampling frequency up to ~1 kHz

**Power capping** is also supported by RAPL

**Accuracy** high (according to *Intel*)

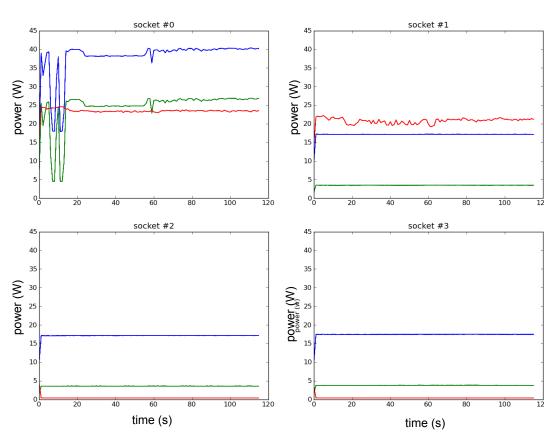
#### 2.2. Where is energy used ? > Chip monitors > RAPL



# **Example of RAPL**

System with 4 sockets
Sockets #0 and #1 working
Sockets #2 and #3 idle

Possible to understand how packages, cores & dram consume energy



#### 2.2. Where is energy used?

# Recap

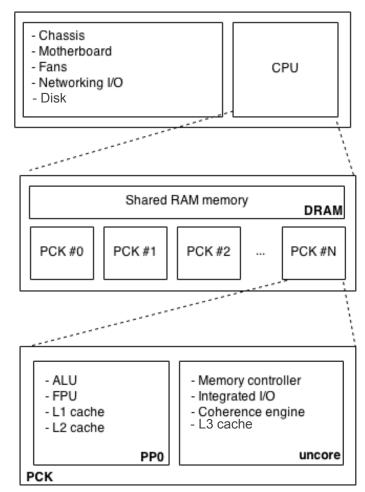
Energy consumption in HTC is an issue

HTC systems are complex

Different tools for different granularities and components:

External measurements

Chip monitors



2.2. Where is energy drained ? > Software-based> IgProf

# **IgProf**

application profiler developed at CERN by the CMS software team

general purpose. open source. not experiment specific measures performance (time spent in functions) and memory usage at *runtime* 

allows developer to understand:

bottlenecks

where code needs to be optimised

cross platform: recently ported to 64-bit ARM, also supports 32-bit ARM, Intel x86 and x86-64

2.2. Where is energy drained ? > Software-based> IgProf

# IgProf & energy profiling

Uses RAPL and PAPI to measure energy consumed.

Map functions and low level operations with energy consumption

more info (strategies, results, examples)

paper and <a href="http://igprof.org/">http://igprof.org/</a>

# 3. Study case

# Comparison ARMv7 vs Intel XEON

32bit ARMv7 is used on smartphones. comparison with Intel XEON

measurements	Internal
	RAPL for Intel
	cross platform chip monitor integrated (TI INA 231) for ARMv7
	External

# Multithreaded

**ParFullCMS** 

Geant4 benchmark application

Uses the CMS geometry

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workload

next: specs

# 3. Study case

ARMv7 Exynos5 Octa Cortex™
4x A15 @ 1.6Ghz and/or A7 cores (big.LITTLE technology)
2 GB RAM
ARMv7/32bit
development board

Intel 32x Intel™ Xeon™ CPU E5-2650 @ 2.00GHz 252 GB RAM system on a rack



### 3. Study case

# What to expect

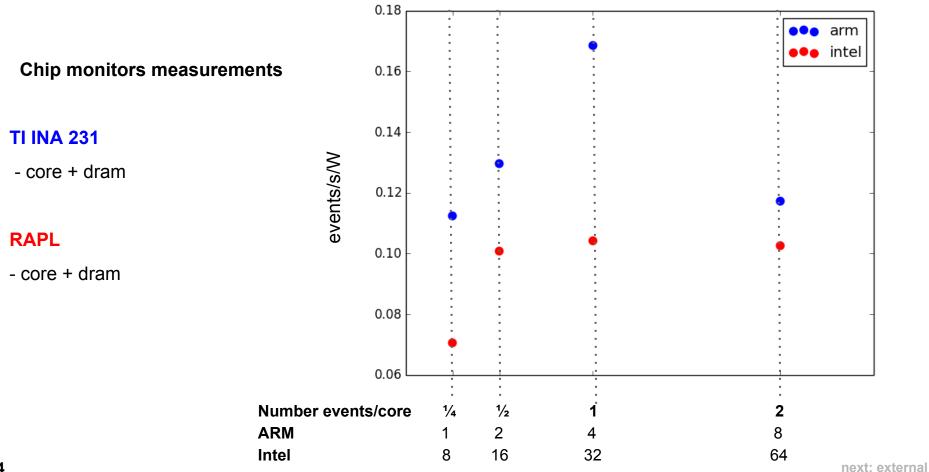
ARMv7 performs better (energy efficiency perspective)

Both ARM and Intel do not perform better when overcommitted (more threads than number cores)

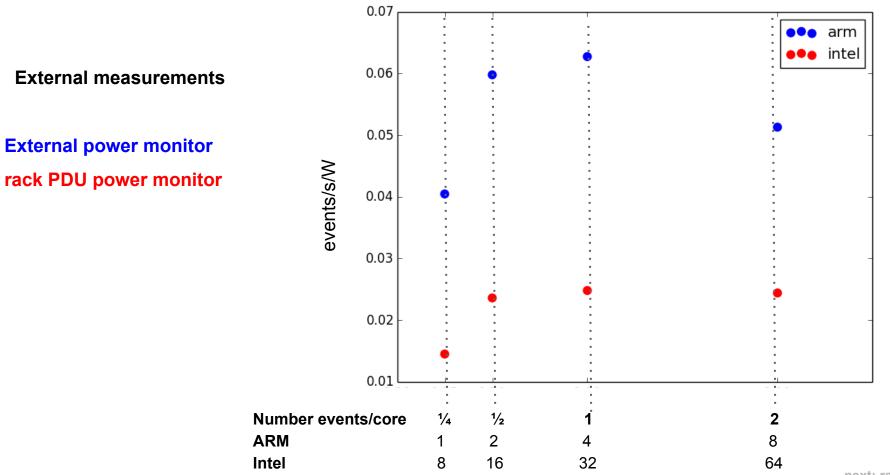
Power consumed ratio external/internal is bigger on Intel (rack vs dev. board)

Chip monitors and external measurement techniques in action

#### 3. Study case > Chip monitors



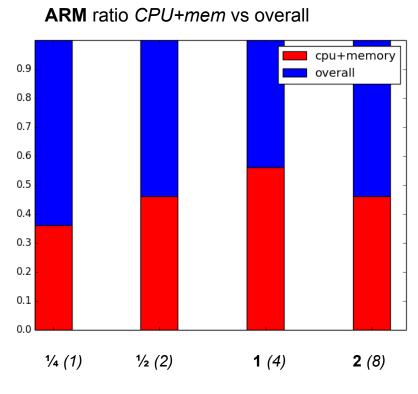
#### 3. Study case > External measurements



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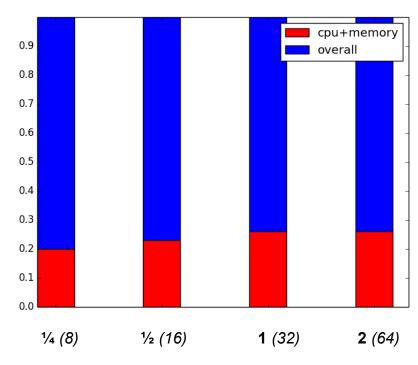
next: ratio

#### 3. Study case > External measurements



**Number events/core** (nr cores)

**Intel** ratio *CPU+mem* vs overall



Number events/core (nr cores)

16 next: conclusions

3. Study case > Comparison ARM vs Intel

32bit ARMv7 with interesting results.

Different system's components → different tools for measurement

**External**, *chip monitors* and **software-based** measurements give good picture of the system's energy consumption at different levels.

### 4. Wrapping up

Energy efficiency is a major concern of HTC

Important to be aware of where and how energy is consumed on a HTC system

There are tools and techniques that account for the different system's components

Recently, **IgProf** was ported for ARM 64 bit and got power profiling capabilities.

ARM keeps showing potential for efficient HTC

